

Amendments to the Claims:

1. (Previously Amended) A peripheral device PCB package comprising: two stamped metal covers with a plastic frame element corresponding to each cover; each cover having a first side and second side with a plurality of fingers extending from said sides and wherein edges of the metal covers are bent to conform to the shape of the frame and said fingers are embedded in the plastic frame elements forming an integral unit, the plastic frame elements being injected molded around the fingers;

and wherein the plastic frame element extends beyond a plane of the metal cover so that a plastic perimeter surface is exposed, thereby facilitating bonding of the two covers.

2. (original) The package as claimed in claim 1 wherein:
ejector pins on the plastic frames are provided to position a PCB.

3. (original) The package as claimed in claim 1 wherein:
the plastic frame elements include a polarizing key.

4. (original) The package as claimed in claim 1 wherein:
the plastic frame elements include energy directors.

5. (original) The package as claimed in claim 1 wherein:
a grounding point is established by metal-to-metal contact of the covers.

6. (original) The package as claimed in claim 1 wherein:
the interiors of the covers are coated with a thin layer of non-conductive material.

7-12. (canceled).

13. (currently amended) The package as claimed in claim ~~12~~ 1 wherein the plastic perimeter surface is integrally formed with the plastic frame elements.

14-28. (canceled).